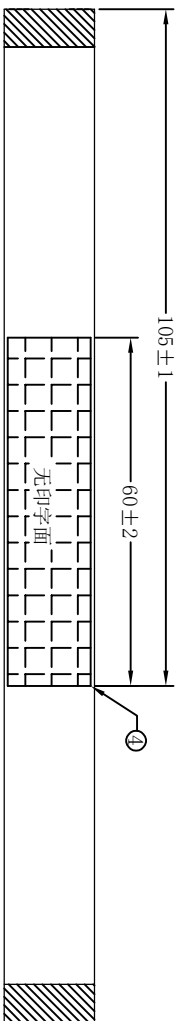
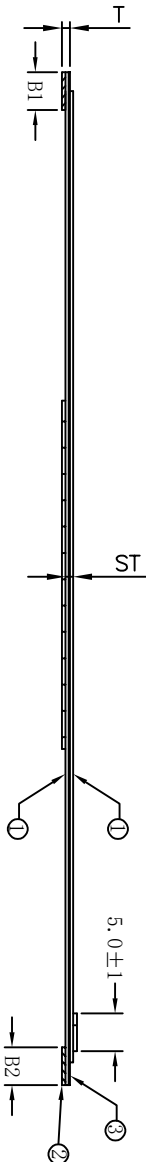
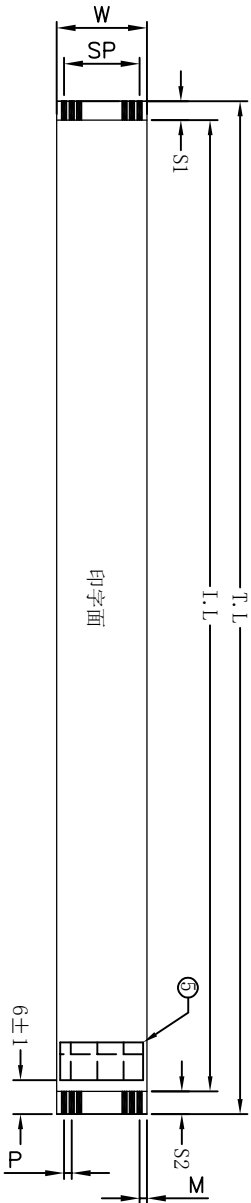


ROHS



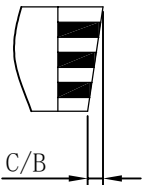
A

STRUCTURE		
NO	ITEM NAME	REMARK
1	INSULATION (绝缘层)	印字U:20624 60um 空白60um
2	P/TAPE (补强板)	AWM 20624 80C 60V VW-1
3	CONDUCTOR (导体镀层)	THICKNESS 0.1 WIDTH 0.65 PLATED Sn(40u") PLATED MIN
4	双面胶	W4*160 GA808
5	双面胶	W4*15 GA808
6		

DIMENSION		
PITCH (间距)	P	1.0 ±0.08
SPAN(全间距)	SP	3.0 ±0.08
WIDTH(总宽度)	W	5.0 ±0.1
MARGIN(边距)	M	1.0 ±0.1
INSERT THICKNESS (插入厚度)	T	0.30 ±0.03
SURFACE THICKNESS (线身厚度)	ST	0.22 ±0.03
PROTECTOR LENGTH (补强板长度)	B1	6.0 ±1
STRIP LENGTH (金手指长度)	S1	4.0 ±0.5
INSULATION LENGTH (绝缘层长度)	I.L	278 ±2.0
TOTAL LENGTH (产品总长度)	T.L	286 ±2.0
NO of PIN(导体数量)	4P	

NOTES:

- 成品之两端内外CB为0--0.5mm
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HECON P/N HC-FFC-1.0-04P-XXX-A-01		HECON 东莞市禾康电子有限公司 DONGGUAN HECON ELECTRONICS CO., LTD	
TITLE 1. 0*4P*286-4/4/6/6 A		APPROVED	
CHECKED		REV	
DRAWN Bot'eng		SHEET	
DESCRIPTION		SIZE	
CHK		A4	
DATE		1/1	
SER			